		<del></del>			<del></del>			
AMENDMENT TRANSMITTAL LETTER (Large Entity) Applicant(s): Kei-Yu Ko							Docket No. 11675.114	
Serial No. 08/846,671		Filing Date April 30, 1997		Examiner George A. Goudreau		eau	Group Art Unit 1763	
hventions, undoped silicon dioxide as etch stop for selective etch of doped silicon dioxide								
TO THE ASSISTANT COMMISSIONER FOR PATENTS:  Transmitted herewith is an amendment in the above-identified application.								
The fee has been calculated and is transmitted as shown below.  SEP 2. 5 2001								
CLAIMS AS AM								478111
	CLAIM	S REMAINING	HIGHEST#	NUMB	ER EXTRA	RATI	# <b>%</b>	ADDITIONAL
		AMENDMENT	PREV. PAID FOR	R CLAIMS	PRESENT	10011	_	FEE
TOTAL CLAIMS		<del>5</del> -	54 =		0	x \$1	8.00	\$0.00
INDEP. CLAIMS		(8 -	8 =		0	x \$8	0.00	\$0.00
Multiple Dependent Claims (check if applicable) \$0.00								
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$0								
No additional fee is required for amendment.  Please charge Deposit Account No. in the amount of A duplicate copy of this sheet is enclosed.  A check in the amount of to cover the filing fee is enclosed.  The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 23-3178  A duplicate copy of this sheet is enclosed.  Any additional filing fees required under 37 C.F.R. 1.16.  Any patent application processing fees under 37 CFR 1.17.  Dated: September 19, 2001    Certify that this document and fee is being deposited on with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.								
cc:					Signo	ature of Per	son Maili	ng Correspondence
<b></b> .								

Typed or Printed Name of Person Mailing Correspondence



## U.S. Express Mail Label No. EL893521051US

PATENT APPLICATION Docket No. 11675.114

> ) Group Art ) Unit 1763

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

)

Kei-Yu Ko

Serial No.: 08/846,671

In re application of:

Filed: April 30, 1997

For: UNDOPED SILICON DIOXIDE AS ETCH

STOP

FOR SELECTIVE ETCH OF DOPED SILICON DIOXIDE

Examiner: George A. Goudreau

**AMENDMENT "D" AND RESPONSE** 

The Honorable Commissioner of Patents and Trademarks
Washington, D. C. 20231

Sir:

In response to the Office Action dated on June 19, 2001 (the "Office Action"), Applicant submits this Amendment "D" and Response. Please amend the above-identified application as follows:

## IN THE CLAIMS:

## CLEAN VERSION OF THE PENDING CLAIMS Under 37 C.F.R. § 1.121(c)(3):

Please amend the claims as indicated below so that the following list presents a clean version of the entire set of pending claims.

Amendment "D" and Response Serial No.08/846,671